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To Whom It May Concern:

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FUJIMI INCORPORATED AND CABOT MICROELECTRONICS CORPORATION
ANNOUNCE COLLABORATION FOR ADVANCED SLURRY DEVELOPMENT

Kiyosu, Aichi, March 29, 2018 – Fujimi Incorporated (TSE: 5384), a pioneer in the field of manufacturing synthetic precision abrasives as well as a leading supplier of silicon wafer lapping abrasives and polishing slurries, and Cabot Microelectronics Corporation (Nasdaq: CCMP), the world's leading supplier of chemical mechanical planarization (CMP) polishing slurries and the second largest CMP pads supplier to the semiconductor industry today announced plans to collaborate in the development of certain advanced CMP solutions for the semiconductor industry.

Fujimi Incorporated and Cabot Microelectronics believe that by working together they can leverage their respective expertise to anticipate and meet customer requirements for innovative CMP solutions for an increasing number of advanced semiconductor applications, including those for augmented reality, artificial intelligence, automotive, high performance computing and 5G wireless broadband technologies.

"We are excited to partner with Cabot Microelectronics to work to bring new technologies to an array of advanced logic and memory applications," said Keishi Seki, President and CEO of Fujimi Incorporated. "Our planned initiative continues our dedication to the development of breakthrough CMP products to solve our customers' most challenging technical problems, and we look forward to the potential for building from this base going forward."

"I am delighted with the opportunities this initial collaboration is designed to provide for our customers and respective companies," said David Li, President and CEO of Cabot Microelectronics. "Fujimi Incorporated and Cabot Microelectronics are both leaders in materials development, with a track record of providing high quality, leading edge CMP solutions to our customers; together, I believe we are even better positioned to develop advanced CMP solutions for the semiconductor industry, which is experiencing unprecedented growth."

ABOUT FUJIMI INCORPORATED

Fujimi Incorporated, headquartered in Kiyosu, Aichi Prefecture, Japan is a pioneer in the manufacturing of synthetic precision abrasives. With a long history of excellence in precision grading technologies, accumulated experience and extensive research and development capabilities, the Company expanded beyond abrasives for optical lenses to develop and deliver a variety of ultraprecision products sought by leading-edge high-tech industries. The company's products include polishing abrasives for silicon wafers and other semiconductor substrates, various CMP products, and abrasives for computer hard disks. The company's mission is to develop new, innovative technologies and applications with a commitment to environmental sustainability, thereby enabling the advancement of technology for the betterment of humanity. The company has approximately 830 employees on a global basis. For more information about Fujimi Incorporated, visit <http://www.fujimiinc.co.jp/english>.

ABOUT CABOT MICROELECTRONICS

Cabot Microelectronics Corporation, headquartered in Aurora, Illinois, USA, is the world's leading supplier of CMP polishing slurries and second largest CMP pads supplier to the semiconductor industry. The company's products play a critical role in the production of advanced semiconductor devices, helping to enable the manufacture of smaller, faster and more complex devices by its customers. The company's mission is to create value by delivering high-performing and innovative solutions that solve its customers' challenges. The company has approximately 1,150 employees on a global basis. For more information about Cabot Microelectronics Corporation, visit www.cabotcmp.com.